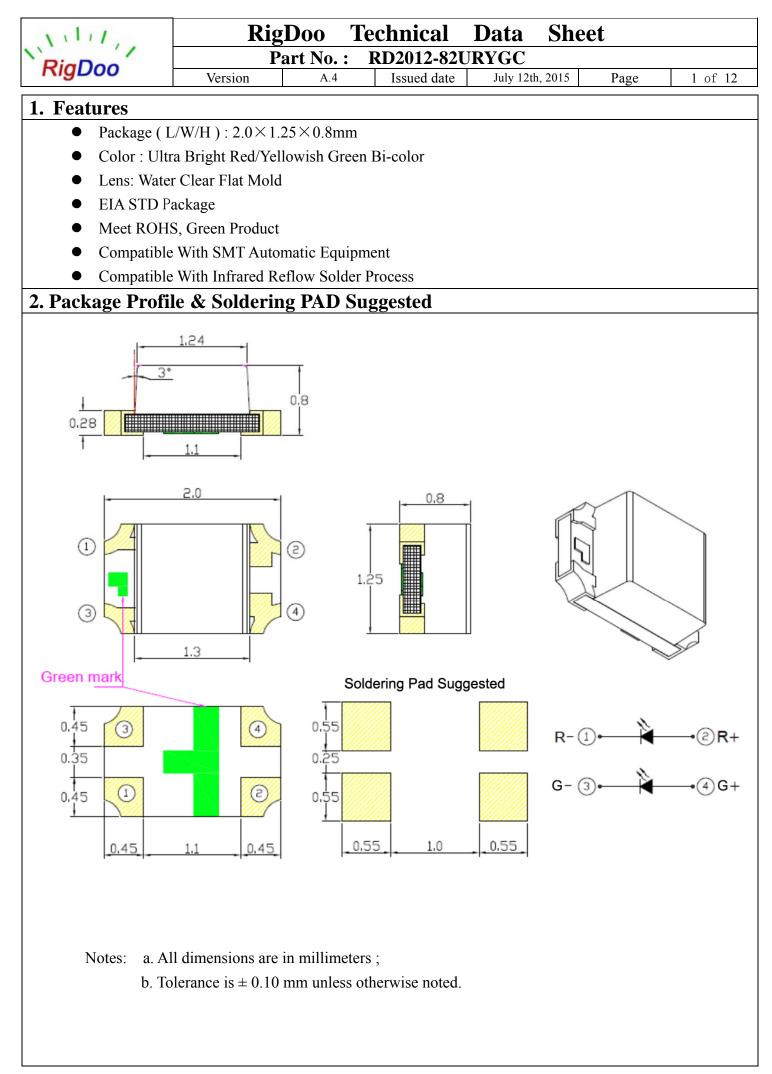


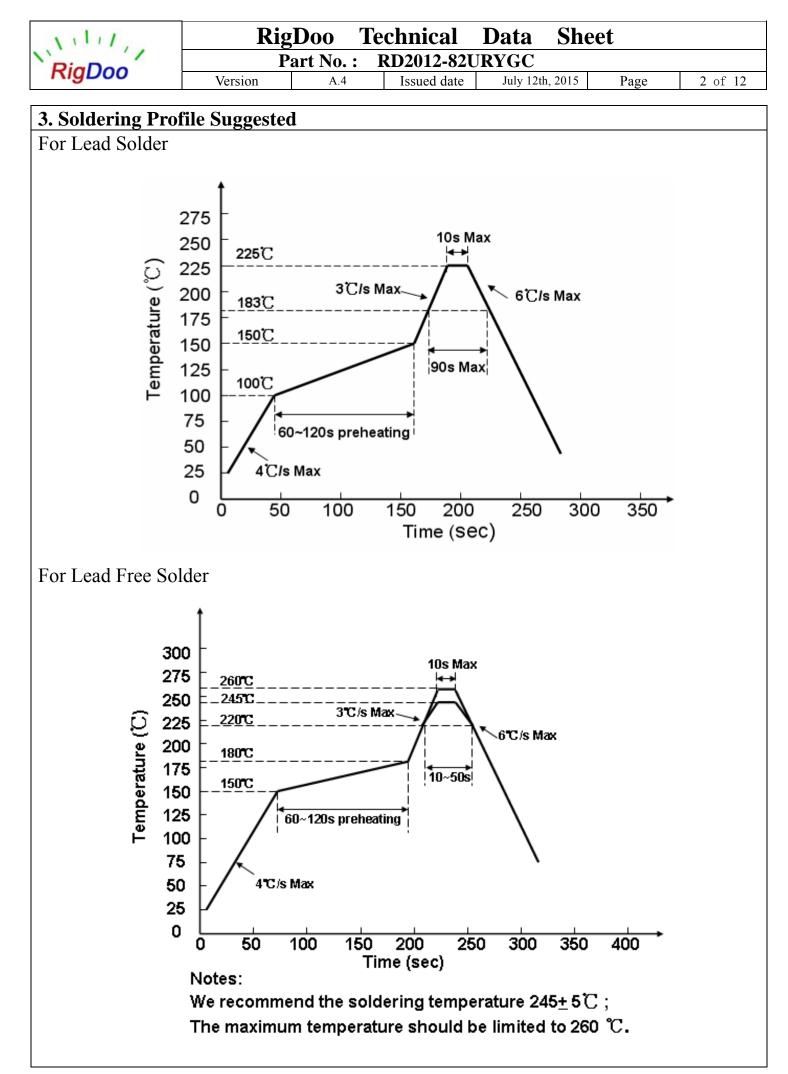
Technical Data Sheet

Product Name:_	0805 2012 Red/Y.Green Bi-Color SMD Chip LED
Part Number: _	RD2012-82URYGC
Customer: _	
Customer PN: _	
Version No.:	A.4
Date:	July 12 th , 2015

Customer Approval

Instituted By:	Checked By:	Approved By:
S	henzhen RigDoo Optoelect	ronics Co., Ltd.
	E-mail: info@rigdoo.c	com
	Http://www.rigdoo.co	om







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4. Absolute Maximum Ratings At Ta=25°C

Version

D (T T •4	
Parameter	Symbol	Rating		Unit	
Power Dissipation	Pd	UR	75	mW	
Power Dissipation	ru	YG	75	111 VV	
Peak Forward Current	Ifp	UR	70	mA	
(1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	YG	70		
DC Forward Current	IF	UR	25	m A	
DC Forward Current	1F	YG	25	— mA	
Deverse Voltage	Va	UR	5	- v	
Reverse Voltage	VR	YG	5	v	
Operating Temperature Range	Topr	-30°C ~ +85°C			
Storage Temperature Range	Tstg	-40°C ~ +90°C			
Soldering Condition	Tsol	Reflow soldering : 260°C For 5 Seconds Hand soldering: 300°C For 3 Seconds			
Electrostatic Discharge	ESD	2000		V	



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5. Electrical Optical Ta=25℃ **Characteristics** At

Version

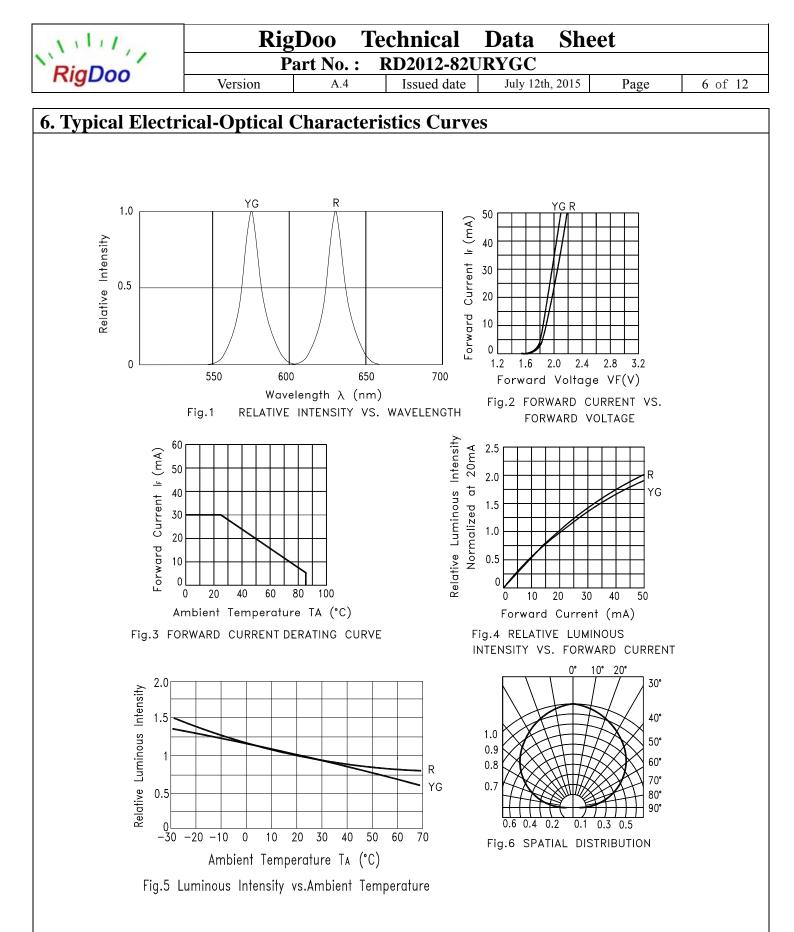
				-			
Parameter	Symbol	Color	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	UR		65		mad	
Luminous Intensity	1 V	YG		40		mcd	IF = 5mA
Dominant Wayalangth	λd	UR	615-		630-		IF = 5mA
Dominant Wavelength	λü	YG	568		572-	nm	
Dools Wayalangth	λp	UR		630		nm	IF = 5mA
Peak Wavelength		YG		570			
Speatral Line Half Width	Δλ	UR		20		222	IF = 5mA
Spectral Line Half-Width	$\Delta \lambda$	YG		00		nm	
Earward Valtaga	VF	UR	1.6		2.2	V	IF = 5mA
Forward Voltage		YG	1.6		2.2		
Reverse Current	IR	UR			5	uA	VR=5V
		YG			5		V N-3 V
Viewing Angle	201/2			120		deg	IF = 5mA

Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Vili/	R	ligDoo Tec	hnical I	Data	Sheet		
RigDoo		Part No. : RD2012-82URYGC					
Rigboo	Version	A.4	Issued date	July 12th, 2	2015	Page	5 of 12
IV-R							
Bin	Min	Μ	ax	Unit	,	Cor	ndition
R1	45	5	6				
R2	56	7	'2	MCI)	IF=5mA	
R3	72	9	00				
IV-YG		·	·				
Bin	Min	M	ax	Unit	- ,	Cor	ndition
B1	28.5	3	35				
B2	35	4	5	MCD		IF=5mA	
B3	45	5	56				
IF-YG Bin	Min	Max	τ	U nit	Co	Condition	
<u> </u>	1.8	1.9		Jnit		Condition	
7	1.0	2.0				IF=5mA	
8	2.0	2.0		V	П		
9	2.0	2.2		·			
IF-R	2.1	2:2					
Bin	Min	Max	U	nit	Co	ndition	
1	1.8	1.9					
2	1.9	2.0					
3	2.0	2.1		V	IF	F=5mA	
4	2.1	2.2					
WLD-R							
Bin	Min	Max	Un	it	Co	ndition	
A	615	620					
В	620	625	nn	nm		IF=5mA	
C	625	630					

	-			
Bin	Min	Max	Unit	Condition
В	568	572		
С			nm	IF=5mA
D				
E				





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CPN: XXXXXX

QTY: XXXX

P/N:

RigDoo

XXXXXX

Rohs

XXXX

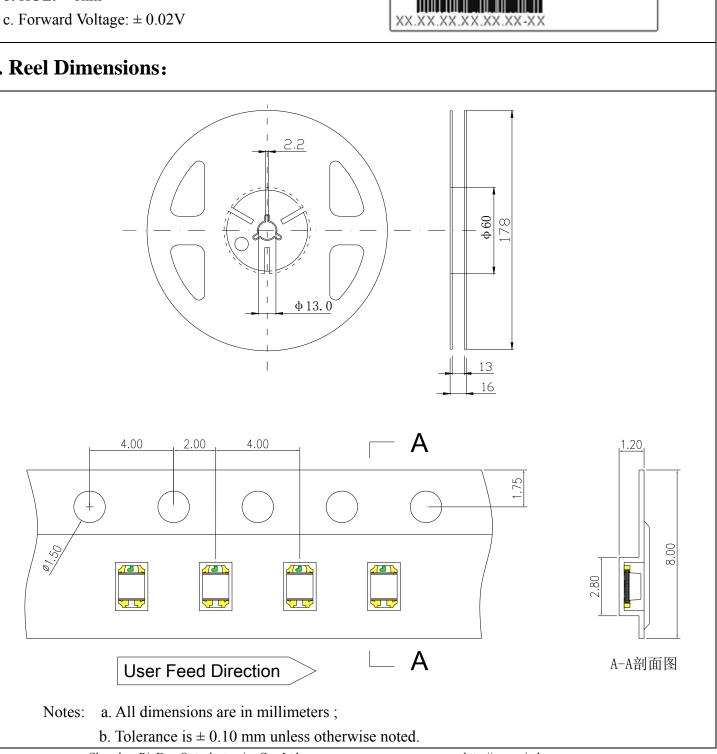
7. Label explanation

- CAT: Luminous Intensity Rank (unit: mcd)
- HUE: Dominant Wavelength Rank (unit : nm)
- REF: Forward Voltage Rank (unit: V)

Rank Tolerance:

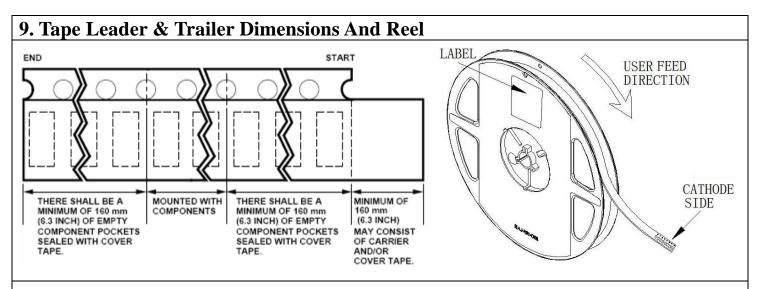
- a. Luminous Intensity: $\pm 11\%$
- b. HUE: ± 1 nm

8. Reel Dimensions:

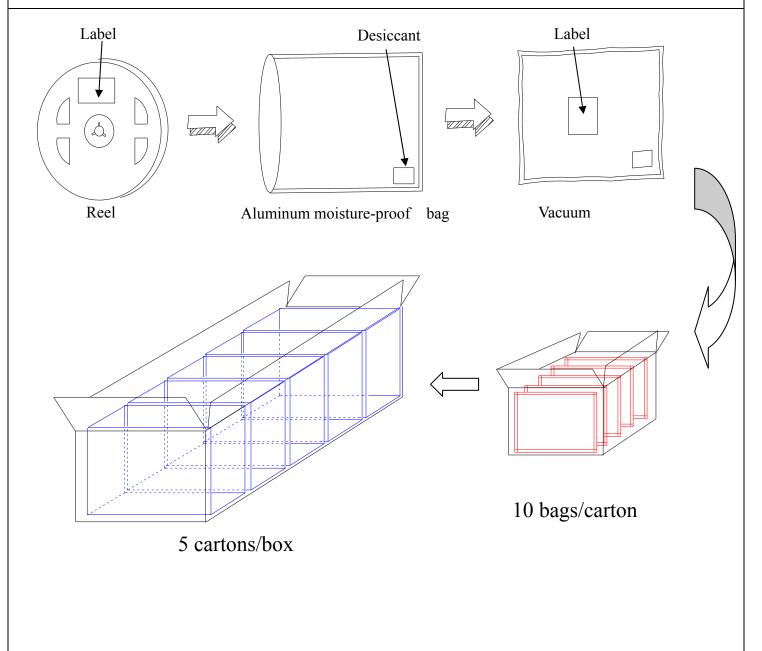




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10. Moisture Resistant Packaging:





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11. Reliability Test							
Classification	Test Item	Test Condition	Reference Standard	Reference Standard			
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating	1000HRS (-24HRS,+72HRS)*@20mA	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1			
Endurance Test	High Temperature, High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 85±5℃,RH= 85%	1000HRS±2HRS	JESD22-A101			
Test	High Temperature Storage	Ta= 105±5℃	1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10			
	Low Temperature Storage	Ta= -55±5℃	1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12			
	Temperature Cycling	105° C ~ 25° C ~ -55° C ~ 25° C 30mins 5mins 30mins 5mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4			
	Thermal Shock	IR-Reflow In-Board, 2 Times $85 \pm 5^{\circ}$ C $\sim -40^{\circ}$ C $\pm 5^{\circ}$ C10mins10mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011			
	Solder Resistance	$T.sol=260 \pm 5^{\circ}C$	$10 \pm 1 \text{secs}$	MIL-STD-202F:210A MIL-STD-750D:2031 JIS C 7021:A-1			
Environmental Test	IR-Reflow Normal Process	Ramp-up rate(183°C to Peak) +3°C/ second max Temp. maintain at 125(±25)°C 120 seconds max Temp. maintain above 183°C 60-150 seconds Peak temperature range 235°C+5/-0°C Time within 5°C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C			
	IR-Reflow Pb Free Process	Ramp-up rate(217°C to Peak) +3°C/ second max Temp. maintain at 175(±25)°C 180 seconds max Temp. maintain above 217°C 60-150 seconds Peak temperature range 260°C+0/-5°C Time within 5°C of actual Peak Temperature (tp) 20-40 seconds Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C			
	Solderability	T.sol= $235 \pm 5^{\circ}$ ℃ Immersion rate 25 ± 2.5 mm/sec Coverage $\geq 95\%$ of the dipped surface	Immersion time 2±0.5 sec	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2			



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12. Cautions

Storage

- 1.Before opening original package, it is recommended to store them in the following environment: Temperature: 5°C~30°C, Humidity: 85%RH max. When the inventory over 2 months, Should be done before treatment using dehumidification, Temperature: 60°C/8 hours.
- 2. After opening original package, the storage ambient for the LEDs should be in 5~30°C temperature and 60% or less relative humidity.
- 3. In order to avoid moisture absorption, it is recommended that the LEDs that out of the original package should be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.
- 4. The LEDs should be used within 168hrs (7 days) after opening the package. Once been mounted, soldering should be quick.
- 5. If the moisture absorbent material (silica gel) has faded away or the LEDs stored out of original package for more than 168hrs (7 days), baking treatment should be performed using the conditions: 60°C at least 24 hours.

ESD (Electrostatic Discharge)-Protection

A LED (especially the Blue, White and Green product) is an ESD sensitive component, and static electricity or power surge will damage the LED. ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light-up" at low currents, etc. Some advice as below should be noticed:

- 1. A conductive wrist strap or anti-electrostatic glove should be worn when handling these LEDs.
- 2. All devices, equipment, machinery, work tables and storage racks, etc. must be properly grounded
- (Grounding impedance value within 10Ω).
- 3. Use anti-static package or boxes to carry and storage LEDs. And ordinary plastic package or boxes is forbidden to use.
- 4. Use ionizer to neutralize the static charge during handling or operating.
- 5. All surfaces and objects within 1 ft close to LEDs measure less than 100V.

Cleaning

Use alcohol-based cleaning solvents such as IPA (isopropyl alcohol) to clean LEDs if necessary.

Soldering

- 1. Soldering condition refer to the draft "Soldering Profile Suggested" on page 1.
- 2. Reflow soldering should not be done more than 2 times.
- 3. Manual soldering is only suggested on repair and rework. The maximum soldering temperature should not exceed 300°C within 3 sec. And the maximum capacity of soldering iron is 30W in power.
- 4. During the soldering process, do not touch the lens at high temperature.
- 5. After soldering, any mechanical force on the lens or any excessive vibration shall not be accepted to apply, also the circuit board shall not be bent as well.



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Others

- 1. The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult RigDoo's Sales in advance for the applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health. (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).
- 2. The light output from the high luminous intensity LEDs may cause injury to human eyes when viewed directly.
- 3. The appearance and specifications of the product may be modified for improvement without prior notice.